Preferred Device

Power MOSFET 3.0 Amps, 60 Volts, Logic Level N-Channel SOT-223

Designed for low voltage, high speed switching applications in power supplies, converters and power motor controls and bridge circuits.

Applications

- Power Supplies
- Converters
- Power Motor Controls
- Bridge Circuits

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Value	Unit
V _{DSS}	60	Vdc
V _{DGR}	60	Vdc
V _{GS}	± 15 ± 20	Vdc Vpk
I _D ID I _{DM}	3.0 1.4 9.0	Adc Apk
PD	2.1 1.3 0.014	Watts Watts W/°C
T _J , T _{stg}	–55 to 175	°C
E _{AS}	74	mJ
R _{θJA} R _{θJA}	72.3 114	°C/W
TL	260	°C
	V _{DSS} V _{DGR} V _{GS} I _D I _D I _D I _D I _D I _D I _D I _D	$\begin{array}{c c} V_{DSS} & 60 \\ \hline V_{DGR} & 60 \\ \hline V_{GS} & \pm 15 \\ \pm 20 \\ \hline I_D & 3.0 \\ I_D & 1.4 \\ \hline I_{DM} & 9.0 \\ \hline P_D & 2.1 \\ 1.3 \\ 0.014 \\ \hline T_J, T_{stg} & -55 \text{ to} \\ 175 \\ \hline E_{AS} & 74 \\ \hline \hline R_{\theta JA} & 72.3 \\ R_{\theta JA} & 114 \\ \hline \end{array}$

 When surface mounted to an FR4 board using 1" pad size, 1 oz. (Cu. Area 0.0995 in²).

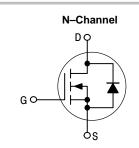
 When surface mounted to an FR4 board using minimum recommended pad size, 2–2.4 oz. (Cu. Area 0.272 in²).

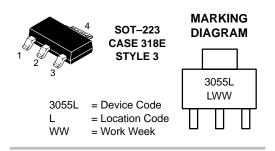


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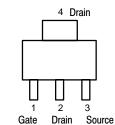
http://onsemi.com

3.0 AMPERES 60 VOLTS R_{DS(on)} = 120 mΩ









ORDERING INFORMATION

Device	Package	Shipping
NTF3055L108T1	SOT-223	1000/Tape & Reel
NTF3055L108T3	SOT-223	4000/Tape & Reel
NTF3055L108T3LF	SOT-223	4000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25° C unless otherwise noted)

$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Charac	Symbol	Min	Тур	Max	Unit	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	OFF CHARACTERISTICS						
	$(V_{GS} = 0 \text{ Vdc}, I_D = 250 \ \mu\text{Adc})$	V _(BR) DSS				Vdc mV/°C	
	$(V_{DS} = 60 \text{ Vdc}, V_{GS} = 0 \text{ Vdc})$	I _{DSS}				μAdc	
	Gate–Body Leakage Current (V _G	$_{\rm S}=\pm$ 15 Vdc, V _{DS} = 0 Vdc)	I _{GSS}	-	-	± 100	nAdc
	ON CHARACTERISTICS (Note 3)						-
	Gate Threshold Voltage (Note 3) ($V_{DS} = V_{GS}$, $I_D = 250 \ \mu Adc$)			1.0		2.0	Vdc mV/°C
$ \begin{array}{ c c c c c c } & (V_{GS} = 5.0 \ Vdc, \ I_{D} = 3.0 \ Adc, \ J_{J} = 150 \ ^{\circ}C) \\ \hline Forward Transconductance (Note 3) & (V_{DS} = 7.0 \ Vdc, \ I_{D} = 3.0 \ Adc) \\ \hline Forward Transconductance (Note 3) & (V_{DS} = 7.0 \ Vdc, \ I_{D} = 3.0 \ Adc) \\ \hline Forward Transconductance (Note 3) & (V_{DS} = 7.0 \ Vdc, \ I_{D} = 3.0 \ Adc) \\ \hline Forward Transconductance (Note 3) & (V_{DS} = 25 \ Vdc, \ V_{GS} = 0 \ V, \ f = 1.0 \ MHz) \\ \hline Forward Capacitance & & & \\ \hline C_{iss} & - & 313 & 440 \\ \hline C_{oss} & - & 112 & 160 \\ \hline C_{rss} & - & 40 & 60 \\ \hline \hline Forward CharActEristics (Note 4) \\ \hline Turn-On Delay Time & & \\ \hline Turn-On Delay Time & & \\ \hline Turn-Off Delay Time & & \\ \hline Fail Time & & & \\ \hline Fail Time & & & \\ \hline Gate Charge & & & \\ \hline (V_{DS} = 48 \ Vdc, \ I_{D} = 3.0 \ Adc, \ V_{GS} = 5.0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS} = 5.0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS} = 5.0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS} = 5.0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS} = 5.0 \ Vdc, \ V_{GS} = 0 \ Vdc, \ V_{GS}$		R _{DS(on)}	-	92	120	mΩ	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$(V_{GS} = 5.0 \text{ Vdc}, I_D = 3.0 \text{ Adc})$	V _{DS(on)}	_			Vdc	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Forward Transconductance (Note 3)	9 _{fs}	-	5.7	-	Mhos	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	DYNAMIC CHARACTERISTICS						-
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Input Capacitance		C _{iss}	-	313	440	pF
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	Output Capacitance		C _{oss}	-	112	160	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Transfer Capacitance	. –	C _{rss}	-	40	60	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	SWITCHING CHARACTERISTICS	6 (Note 4)					
$\begin{array}{c c c c c c c } \hline U_{GS} = 5.0 \ Vdc, \\ R_G = 9.1 \ \Omega) \ (Note 3) \end{array} & \begin{array}{c c c c c c } \hline I_{d} & I_{G} & I_{G} & I_{G} \\ \hline I_{d} & I_{G} \\ \hline I_{d$	Turn–On Delay Time		t _{d(on)}	-	11	25	ns
$\begin{tabular}{ c c c c c c c c c c c } \hline Turn-Off Delay Time & $R_G = 9.1 \ \Omega$) (Note 3$) & $t_{d(off)}$ & $-$ & 22 & 45 \\ \hline $Fall Time & t_f & $-$ & 27 & 60 \\ \hline $Gate Charge & $(V_{DS} = 48 \ Vdc, \ I_D = 3.0 \ Adc, \ V_{GS} = 5.0 \ Vdc) (Note 3$) & Q_T & $-$ & 7.6 & 15 & nC \\ \hline Q_1 & $-$ & 1.4 & $-$ & Q_2 & $-$ & 4.0 & $-$ & Q_2 & $-$ & 4.0 & $-$ & Q_1 & $-$ & 1.4 & $-$ & Q_2 & $-$ & 4.0 & $-$ & Q_2 & $-$ & 0.87 & 1.0 & Q_2 & $-$ & 0.87 & 1.0 & Q_1 & $-$ & Q_1 & $-$ & Q_2 & $-$ & Q_1 & $-$ & Q_2 & $-$ & Q_1 & $-$ & Q_2 & $-$ & Q_1 & $-$ & Q_1 & $-$ & Q_2 & Q_1 & $-$ & Q_1 & $-$ & Q_2 & Q_1 & $-$ & Q_1 & Q_1 & Q_1 & Q_1 & Q_1 & Q_1 & Q_2 & Q_1 & $Q_1$$	Rise Time		t _r	-	35	70	-
Gate Charge Q_T - 7.6 15 nC $(V_{DS} = 48 \text{ Vdc}, I_D = 3.0 \text{ Adc}, V_{GS} = 5.0 \text{ Vdc}) (Note 3)$ Q_T - 1.4 - - Q_2 - 4.0 - - Q_2 - 4.0 - - - Q_2 - 4.0 -	Turn–Off Delay Time		t _{d(off)}	-	22	45	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Fall Time			-	27	60	-
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Gate Charge		QT	-	7.6	15	nC
Q2 - 4.0 - SOURCE-DRAIN DIODE CHARACTERISTICS VSD - 0.87 1.0 Vdc Forward On-Voltage (I _S = 3.0 Adc, V _{GS} = 0 Vdc, (I _S = 3.0 Adc, V _{GS} = 0 Vdc, T _J = 150°C) (Note 3) VSD - 0.87 1.0 Vdc Reverse Recovery Time t_{rr} - 35 - ns (I _S = 3.0 Adc, V _{GS} = 0 Vdc, T _J = 150°C) (Note 3) t_a - 21 -			Q ₁	-	1.4	-	
Forward On–Voltage $(I_S = 3.0 \text{ Adc}, V_{GS} = 0 \text{ Vdc})$ $(I_S = 3.0 \text{ Adc}, V_{GS} = 0 \text{ Vdc},$ $T_J = 150^{\circ}\text{C})$ (Note 3) V_{SD} $ 0.87$ 0.72 $1.0- Vdc Reverse Recovery Time t_{rr} 35 ns (I_S = 3.0 \text{ Adc}, V_{GS} = 0 \text{ Vdc},(I_S = 3.0 \text{ Adc}, V_{GS} = 0 \text{ Vdc}, t_a 21 -$			Q ₂	-	4.0	-	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	SOURCE-DRAIN DIODE CHARA	CTERISTICS					•
$(I_{S} = 3.0 \text{ Adc}, V_{GS} = 0 \text{ Vdc}, t_{a} - 21 - d_{a} (d_{a} - d_{a} $	Forward On–Voltage	$(I_{S} = 3.0 \text{ Adc}, V_{GS} = 0 \text{ Vdc},$	V _{SD}			1.0 _	Vdc
	Reverse Recovery Time		t _{rr}	-	35	-	ns
$d_{12}/dt = 100 A/\mu s$ (Note 3)		(I _S = 3.0 Adc, V _{GS} = 0 Vdc,	ta	-	21	-	1
			t _b	-	14	-	1

Reverse Recovery Stored Charge

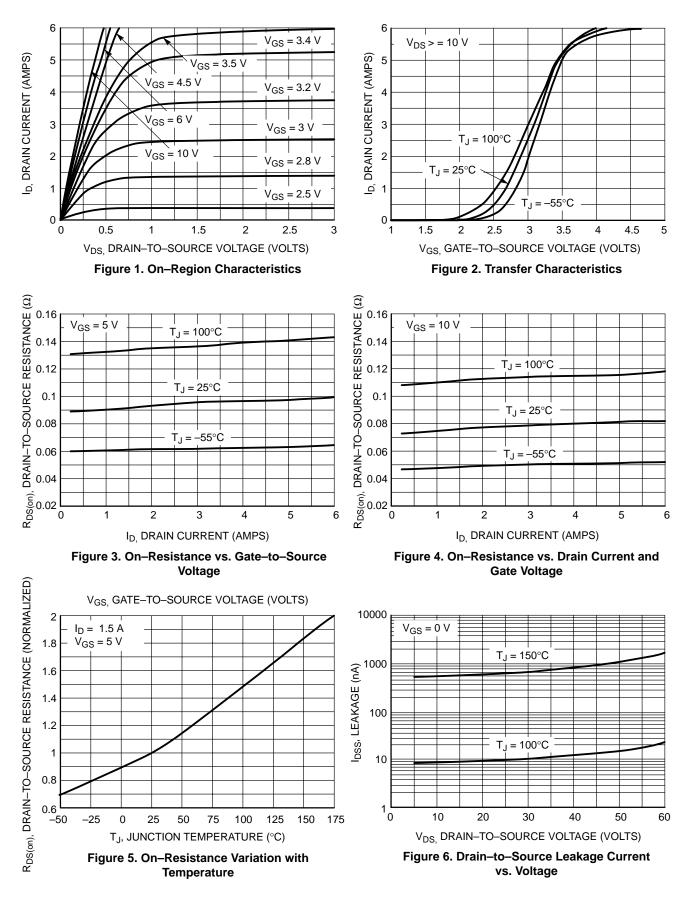
Q_{RR}

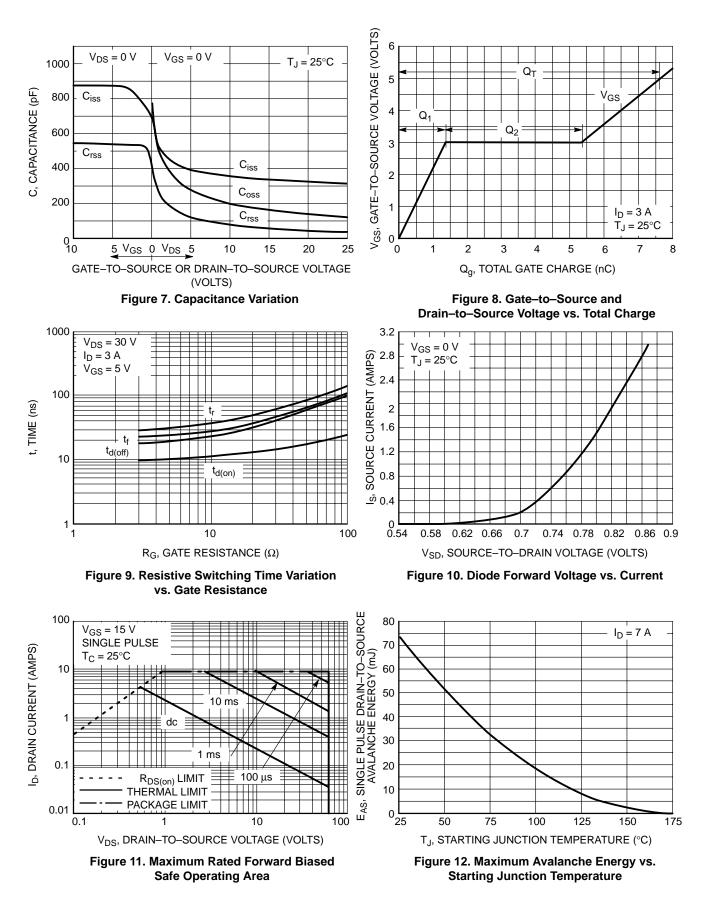
μC

0.044

_

_





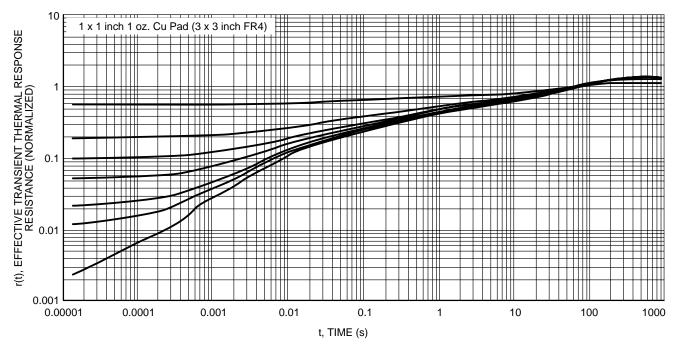
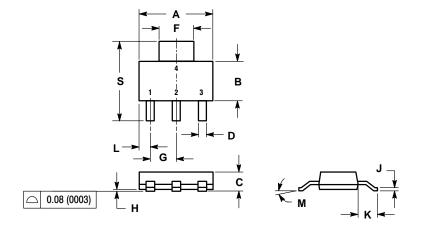


Figure 13. Thermal Response

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 ISSUE K



NOT	ES:
1.	DIMENSIONING AND TOLERANCING PER ANSI
	Y14.5M, 1982.
2.	CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.249	0.263	6.30	6.70
В	0.130	0.145	3.30	3.70
С	0.060	0.068	1.50	1.75
D	0.024	0.035	0.60	0.89
F	0.115	0.126	2.90	3.20
G	0.087	0.094	2.20	2.40
Н	0.0008	0.0040	0.020	0.100
J	0.009	0.014	0.24	0.35
Κ	0.060	0.078	1.50	2.00
L	0.033	0.041	0.85	1.05
Μ	0 °	10 °	0 °	10 °
S	0.264	0.287	6.70	7.30

STYLE 3: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

<u>Notes</u>

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